

Structure and Method of Embedding Components in a Multi-Layer Substrate
Inventors: McCormack, I al.
Application No.: 09/886,092

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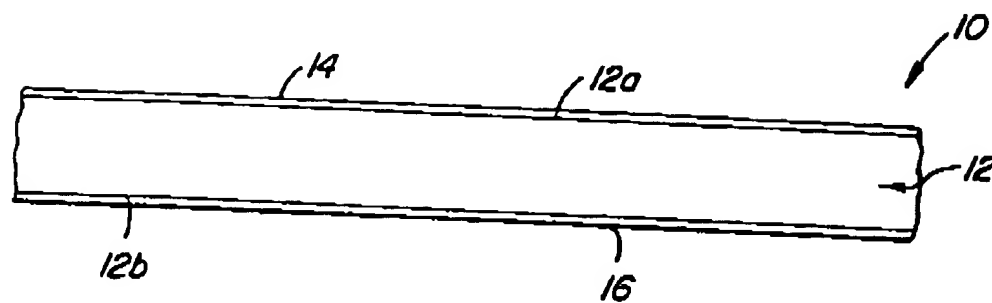


FIG. 1.

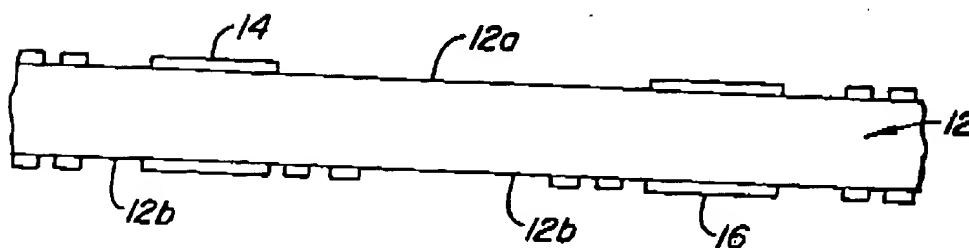


FIG. 2.

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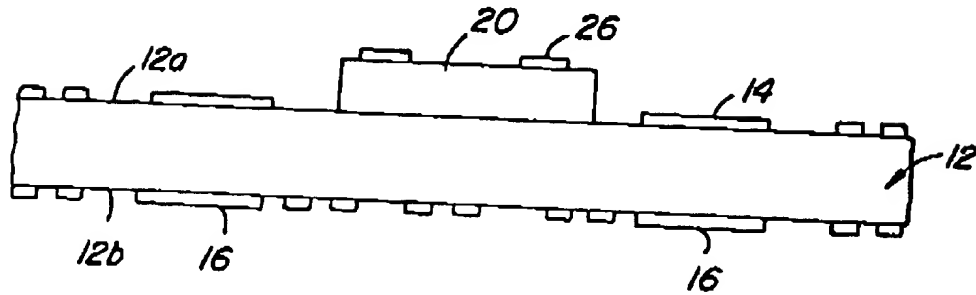


FIG. 3.

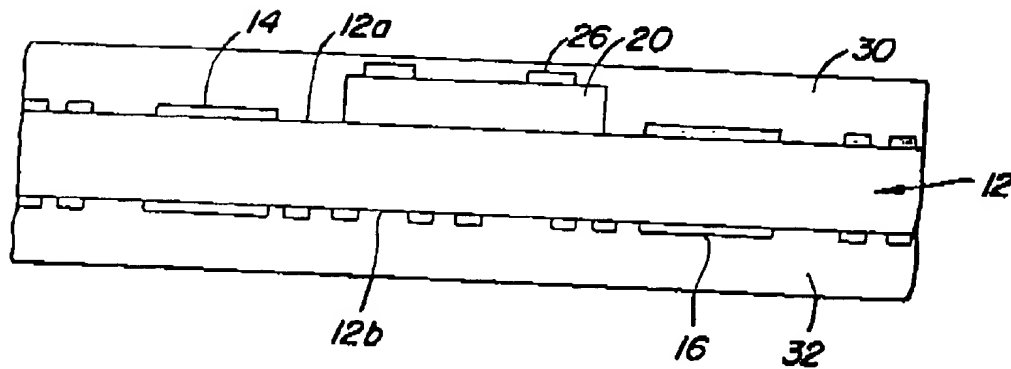


FIG. 4.

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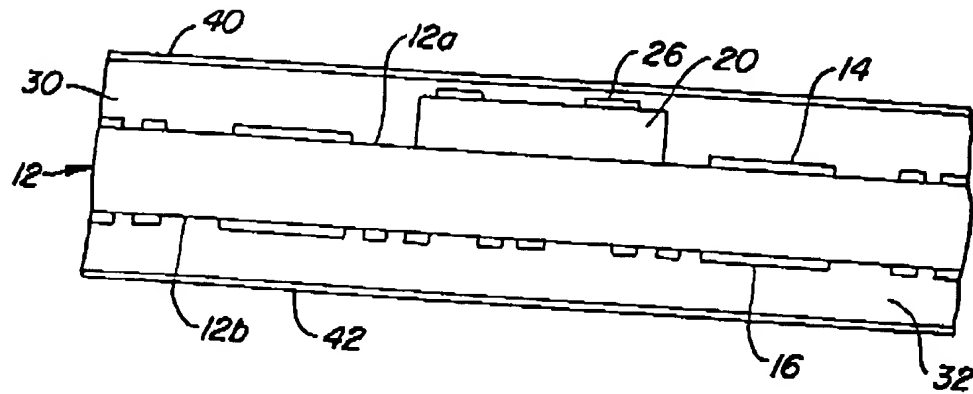


FIG. 5.

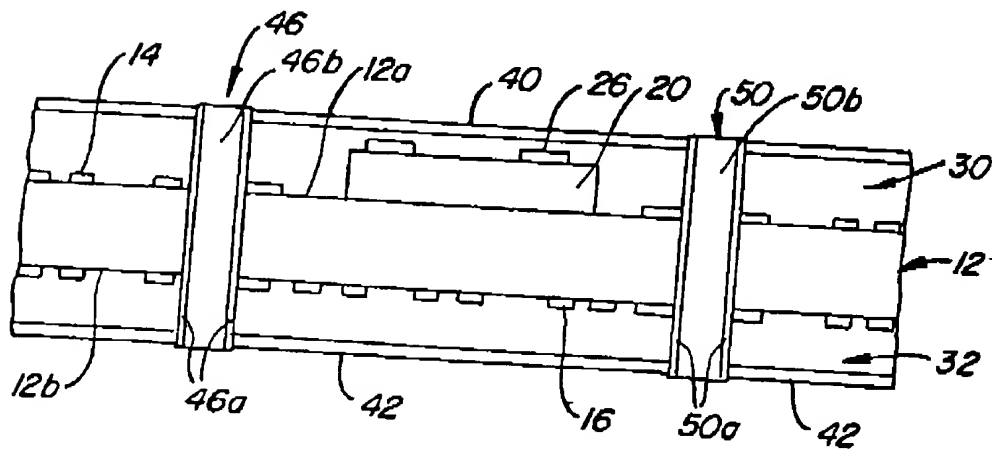


FIG. 6.

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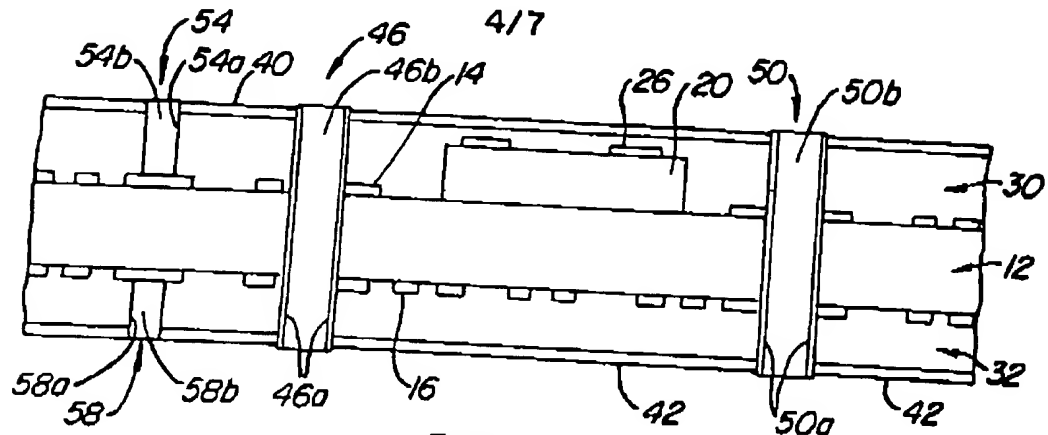


FIG. 7.

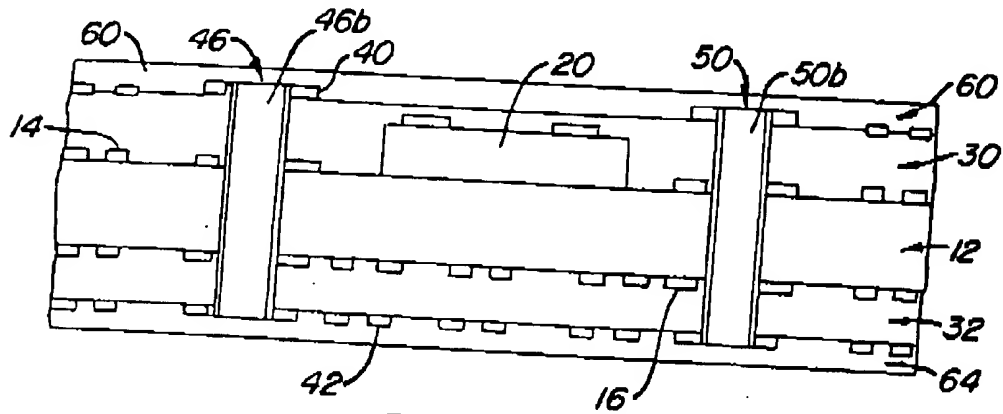


FIG. 8.

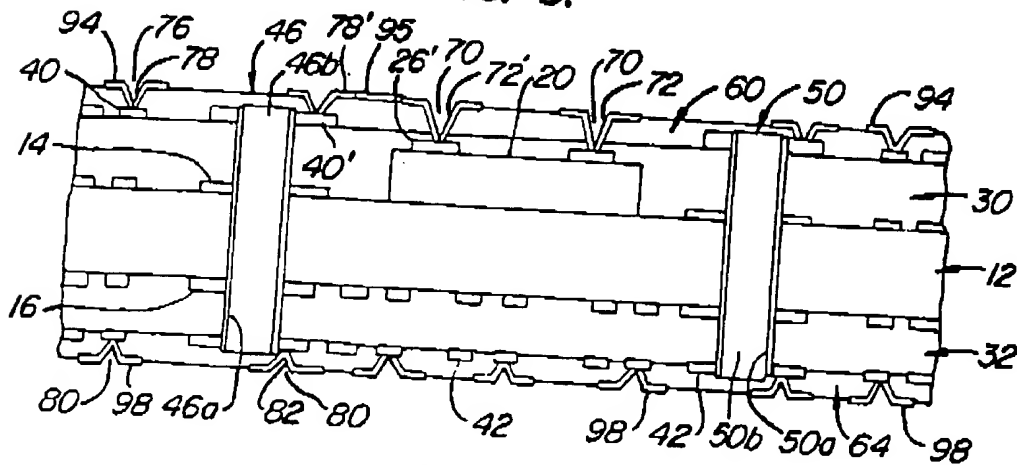


FIG. 9.

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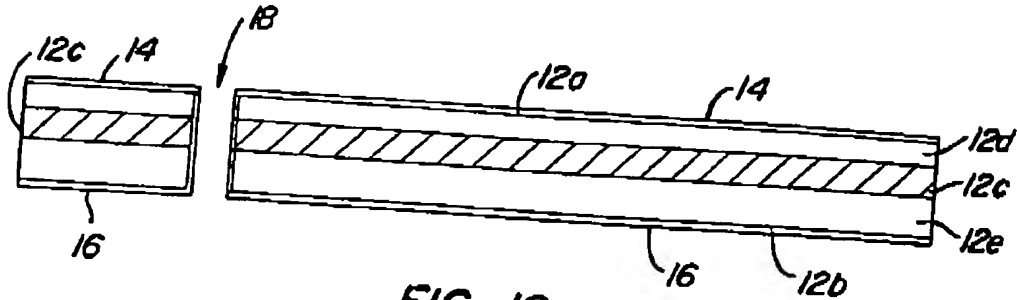


FIG. 10.

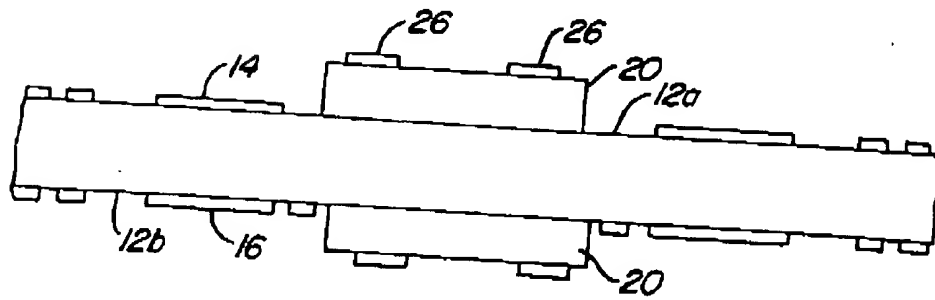


FIG. 11.

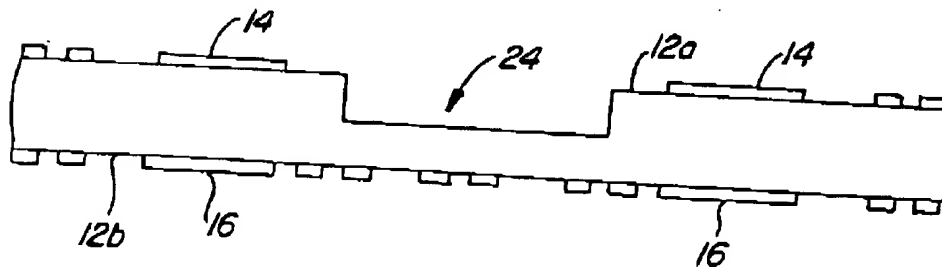


FIG. 12.

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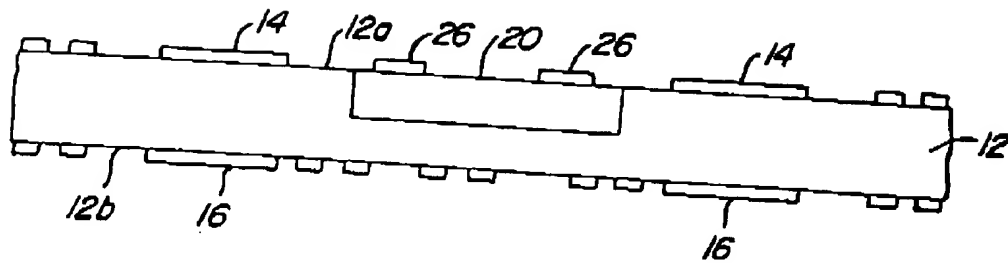


FIG. 13.

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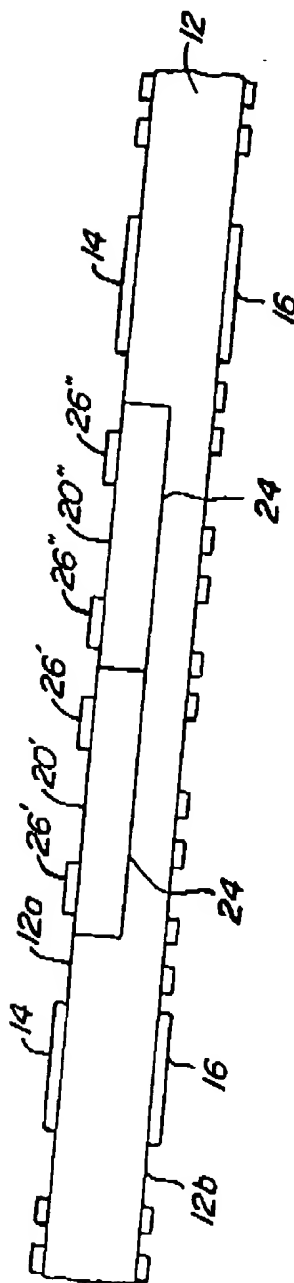


FIG. 14.